

Description

This Bipolar Junction Transistor (BJT) is designed to meet the stringent requirements of automotive applications.

Features

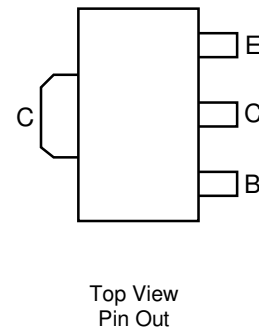
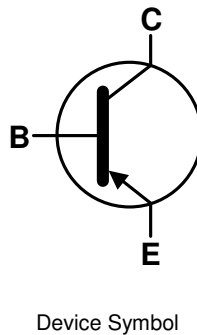
- $BV_{CEO} > -40V$
- Maximum Continuous Current $I_C = -1A$
- Low Saturation Voltage $V_{CE(SAT)} < -500mV @ -1A$
- Complementary NPN type: FCX491AQ
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

Mechanical Data

- Case: SOT89
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.05 grams (Approximate)

Application

- Power MOSFET & IGBT Gate Driving
- Low Loss Power Switching

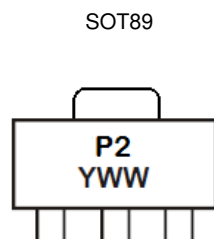


Ordering Information (Note 5)

Product	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
FCX591AQTA	P2	7	12	1,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
 5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



P2 = Product Type Marking Code
 YWW = Date Code Marking
 Y = Last Digit of Year (ex: 6 = 2016)
 WW = Week Code (01 to 53)

Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-40	V
Collector-Emitter Voltage	V _{CEO}	-40	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current	I _C	-1	A
Peak Pulse Current	I _{CM}	-2	A
Peak Base Current	I _B	-200	mA

Thermal Characteristics

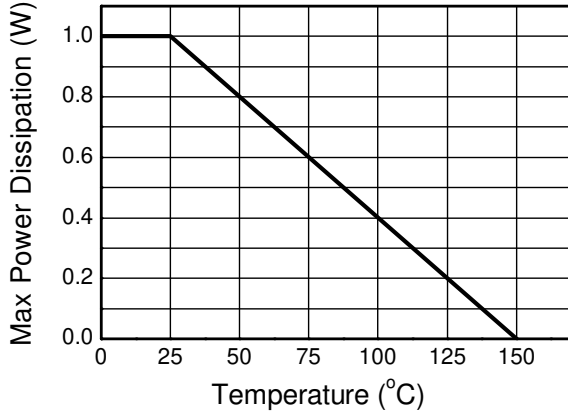
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	1	W
Thermal Resistance, Junction to Ambient Air (Note 6)	R _{θJA}	125	°C/W
Thermal Resistance, Junction to Leads (Note 7)	R _{θJL}	10.01	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

ESD Ratings (Note 8)

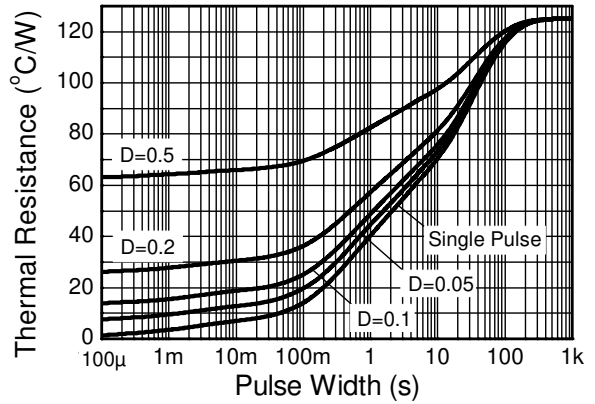
Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	8,000	V	3B
Electrostatic Discharge - Machine Model	ESD MM	400	V	C

- Notes:
6. For a device surface mounted on 15mm X 15mm FR-4 PCB with high coverage of single sided 1 oz copper, in still air conditions; device measured when operating in steady state condition.
 7. Thermal resistance from junction to solder-point (on the exposed collector pad).
 8. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

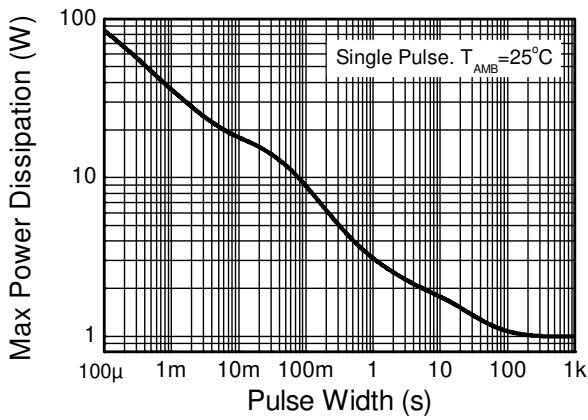
Thermal Characteristics and Derating Information



Derating Curve



Transient Thermal Impedance



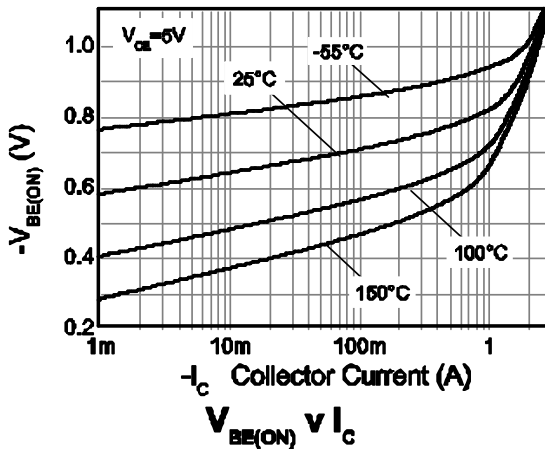
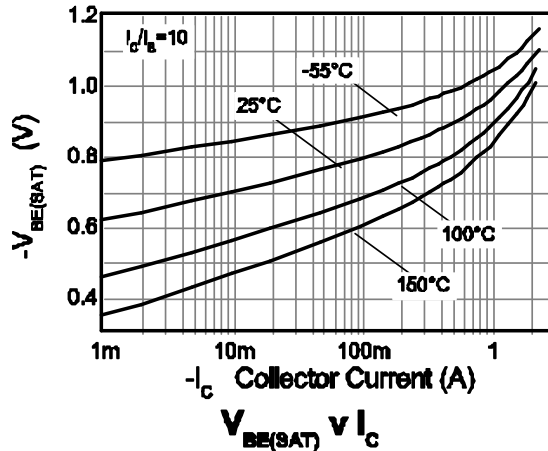
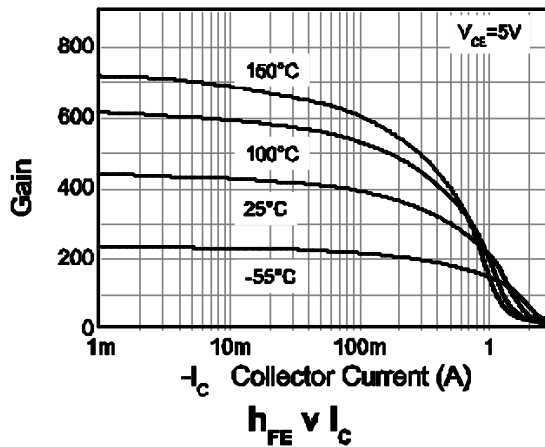
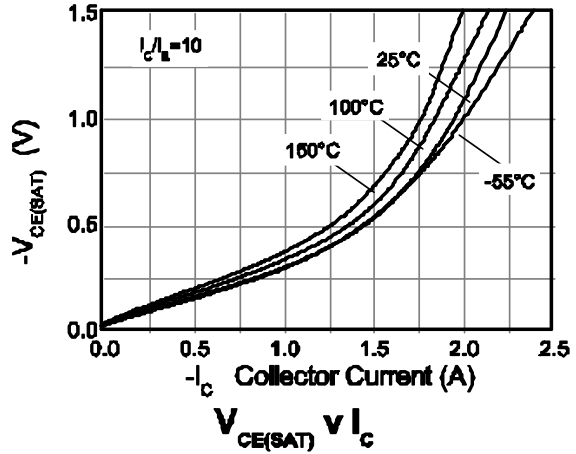
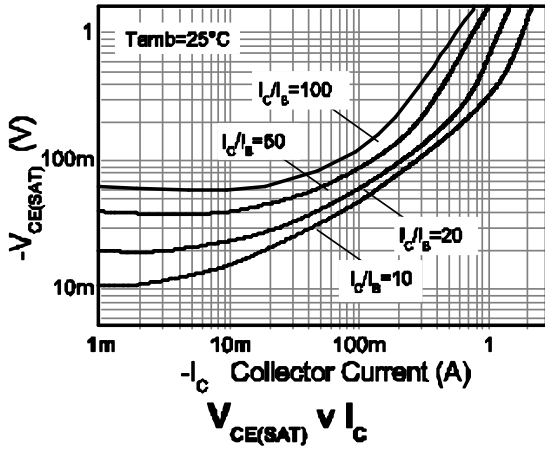
Pulse Power Dissipation

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-40	-	-	V	I _C = -100μA
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	-40	-	-	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-	-	V	I _E = -100μA
Collector Base Cutoff Current	I _{CBO}	-	-	-100	nA	V _{CB} = -30V
Emitter Base Cutoff Current	I _{EBO}	-	-	-100	nA	V _{EB} = -4V
Collector Cutoff Current	I _{CES}	-	-	-100	nA	V _{CES} = -30V
DC Current Transfer Static Ratio (Note 9)	h _{FE}	300	-	-	-	I _C = -1mA, V _{CE} = -5V
		300	-	800		I _C = -100mA, V _{CE} = -5V
		250	-	-		I _C = -500mA, V _{CE} = -5V
		160	-	-		I _C = -1A, V _{CE} = -5V
		30	-	-		I _C = -2A, V _{CE} = -5V
Collector-Emitter Saturation Voltage (Note 9)	V _{CE(SAT)}	-	-	-0.2	V	I _C = -100mA, I _B = -1mA
		-	-	-0.35		I _C = -500mA, I _B = -20mA
		-	-	-0.5		I _C = -1A, I _B = -100mA
Base-Emitter Saturation Voltage (Note 9)	V _{BE(SAT)}	-	-	-1.1	V	I _C = -1A, I _B = -50mA
Base-Emitter Turn-on Voltage (Note 9)	V _{BE(ON)}	-	-	-1.0	V	I _C = -1A, V _{CE} = -5V
Transitional Frequency	f _T	150	-	-	MHz	I _E = -50mA, V _{CE} = -10V f = 100MHz
Output Capacitance	C _{obo}	-	-	10	pF	V _{CB} = -10V, f = 1MHz

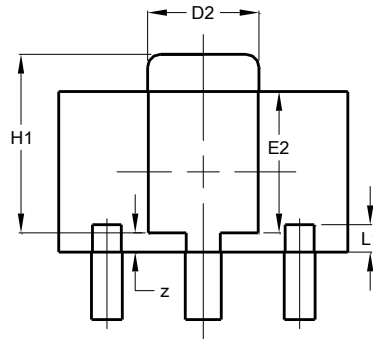
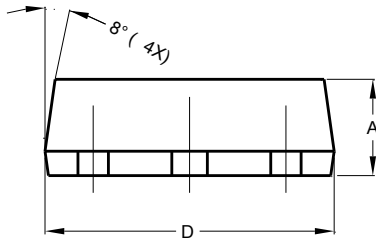
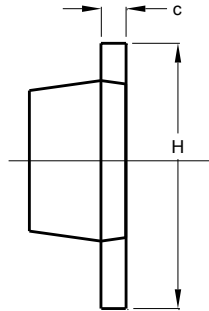
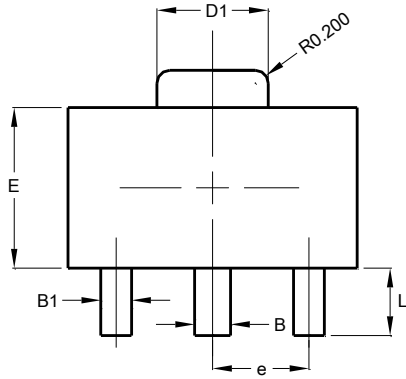
Notes: 9. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



Package Outline Dimensions

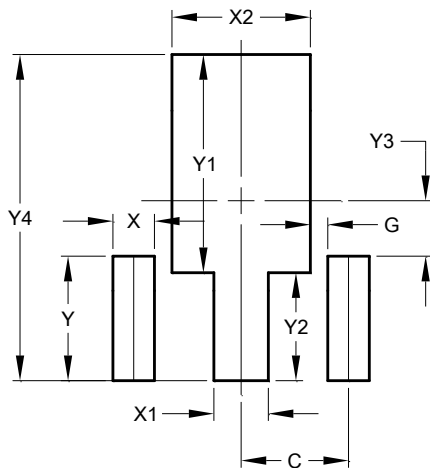
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



SOT89			
Dim	Min	Max	Typ
A	1.40	1.60	1.50
B	0.50	0.62	0.56
B1	0.42	0.54	0.48
c	0.35	0.43	0.38
D	4.40	4.60	4.50
D1	1.62	1.83	1.733
D2	1.61	1.81	1.71
E	2.40	2.60	2.50
E2	2.05	2.35	2.20
e	-	-	1.50
H	3.95	4.25	4.10
H1	2.63	2.93	2.78
L	0.90	1.20	1.05
L1	0.327	0.527	0.427
z	0.20	0.40	0.30
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	1.500
G	0.244
X	0.580
X1	0.760
X2	1.933
Y	1.730
Y1	3.030
Y2	1.500
Y3	0.770
Y4	4.530

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